

L Number	Hits	Search Text	DB	Time stamp
1	2505256	semiconductor ic chip die (integrated adj circuit)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 10:28
2	108014	leadframe (lead adj frame) paddle (die adj2 pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 10:29
3	115259	leadframe (lead adj frame) paddle ((chip dice die) adj2 pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 10:30
4	57547	(semiconductor ic chip die (integrated adj circuit)) same (leadframe (lead adj frame) paddle ((chip dice die) adj2 pad) )	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 10:30
5	2817	half adj6 (etching etched etch)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 10:31
6	586	((semiconductor ic chip die (integrated adj circuit)) same (leadframe (lead adj frame) paddle ((chip dice die) adj2 pad) )) and (half adj6 (etching etched etch))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 10:31
7	1		USPAT	2004/04/10 11:22
8	1		USPAT	2004/04/10 11:22
9	1		USPAT	2004/04/10 11:23
10	1		USPAT	2004/04/10 11:23
11	1		USPAT	2004/04/10 11:23
12	1		USPAT	2004/04/10 11:23
13	1		USPAT	2004/04/10 11:24
14	1		USPAT	2004/04/10 11:24
15	1		USPAT	2004/04/10 11:24
16	1		USPAT	2004/04/10 11:24
17	1		USPAT	2004/04/10 11:24
18	1		USPAT	2004/04/10 11:24
19	1		USPAT	2004/04/10 11:25
20	1		USPAT	2004/04/10 11:26
21	1		USPAT	2004/04/10 11:26
22	1		USPAT	2004/04/10 11:26
23	1		USPAT	2004/04/10 11:26
24	1		USPAT	2004/04/10 11:27
25	1		USPAT	2004/04/10 11:27

26	1		USPAT	2004/04/10 11:27
27	1		USPAT	2004/04/10 11:27
28	1		USPAT	2004/04/10 11:27
29	1		USPAT	2004/04/10 11:27
30	1		USPAT	2004/04/10 11:34
31	1		USPAT	2004/04/10 11:34
32	1		USPAT	2004/04/10 11:35
33	1		USPAT	2004/04/10 11:35
34	1		USPAT	2004/04/10 11:35
35	1		USPAT	2004/04/10 11:35
36	1		USPAT	2004/04/10 11:35
37	1		USPAT	2004/04/10 11:36
38	1		USPAT	2004/04/10 11:36
39	1		USPAT	2004/04/10 11:36
40	1		USPAT	2004/04/10 11:36
41	1		USPAT	2004/04/10 11:37
42	1		USPAT	2004/04/10 11:37
43	1		USPAT	2004/04/10 11:37
44	1		USPAT	2004/04/10 11:37
45	1		USPAT	2004/04/10 11:37

L Number	Hits	Search Text	DB	Time stamp
671	58	(aperture) with (half adj6 (etching etched etch))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/10 14:44